



BSI Standards Publication

Information technology — UPnP Device Architecture

Part 24-2: Internet gateway device control protocol —
Level 2 — Wide area network connection device

National foreword

This British Standard is the UK implementation of ISO/IEC 29341-24-2:2017.

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A list of organizations represented on this committee can be obtained on request to its secretary.

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**Information technology — UPnP
Device Architecture —**

**Part 24-2:
Internet gateway device control
protocol — Level 2 — Wide area
network connection device**

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ISO/IEC 29341-24-2 was prepared by UPnP Forum and adopted, under the PAS procedure, by joint technical committee ISO/IEC JTC 1, *Information technology*, in parallel with its approval by national bodies of ISO and IEC.

The list of all currently available parts of ISO/IEC 29341 series, under the general title *Information technology — UPnP Device Architecture*, can be found on the [ISO web site](#).

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